

SrTiO₃

SrTiO₃ is an excellent and wide applied high T_c superconductive single crystalline substrate. Its lattice constant (3.905Å) fits the common high T_c superconductive material YBCO (3.88 Å) very well. It has twin-less crystal structure and very good physical and mechanical properties for film growth. It is suitable for various high T_c films such as YBCO, Bi-system, La-system and others. It is also suitable for different film growth technologies such as Magnet Sputtering, Pulsed Laser Deposition (PLD), Vapourization, MOCVD, CVD, and laser MBE etc. Films made by these materials and technologies on SrTiO₃ substrate have excellent performance, for instance T_c > 90°, J_c > = 10⁶A/cm².

Basic Properties

Crystal Structure	Cubic m3m, Perovskite
Cell Parameter	a=3.905Å
Melting point	2353K
Density	5.117g/cm ³
Specific Heat	0.544J/gk (300K)
Thermal Conductivity	11.2W/mk
Thermal Expansion	9.4x10 ⁻⁶ k ⁻¹
Dielectric Constant (ε _r)	300(295K), 2000(80K), (7-15GHz)
Dielectric Loss (tgδ)	5x10 ⁻⁴ (295K), 2.5x10 ⁻⁴ (80K), Microwave
Mohs Hardness	6-6.5
Growth Method	Flame

Substrate Specifications

Standard Size	Φ25, 20x20, 10x10, 10x5, 10x3mm, or customer design
Thickness	0.5mm, 1.0mm
Thickness Tolerance	±0.02mm or ±0.005mm for special order
Polish	one or two sides
Orientation	[100], [110], [111]
Orientation Accuracy	±0.5°
Edge Orientation Accuracy	2° (or 1° for special order)
Cut with Special Tilt Angle	available (tilt angle: 1° — 45°)
Micro Roughness Ra	≤5Å (5μm×5μm)

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MgO

Magnesium Oxide substrate is widely used for various films: magnet film, semiconductive film, optical film as well as high Tc superconductive film. MgO crystal is possible to get large size (larger than 2 inch) and has low dielectric loss in microwave band, so it is an important material for high Tc superconductive microwave devices in the mobile communication as well as other industrial areas.

Basic Properties

Crystal Structure	Cubic, m3m, NaCl Type
Cell Parameter	a = 4.213 Å
Melting Point	3250K
Density	3.58g/cm ³
Specific Heat	0.879J/g·k (298K)
Thermal Conductivity	59W/m·k (300K)
Thermal Expansion	11x10 ⁻⁶ k ⁻¹ (300K)
Dielectric Constant (ε _r)	9.8(295K), 9.7(80K), (17-28GHz)
Dielectric Loss (tgδ)	3.5x10 ⁻⁶ (80K) microwave
Mohs Hardness	5.5
Growth Method	Arc Melt

Substrate Specifications

Standard Size	Φ 2" , 2"x2", 20x20, 10x10, 10x5,10x3mm, or customer design
Thickness	0.5mm, 1.0mm
Thickness Tolerance	±0.02mm or ±0.005mm for special order
Polish	one or two sides
Orientation	[100], [110], [111]
Orientation Accuracy	±0.5°
Edge Orientation Accuracy	2° (or 1° for special order)
Cut with Special Tilt Angle	available (tilt angle:1° – 45°)
Micro Roughness Ra	≤5Å (5μm×5μm)

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LaAlO₃

LaAlO₃ single crystal has a lattice constant ($a=3.790 \text{ \AA}$) which fits high T_c superconductive material (such as YBCO: 3.86 \AA) very well, proper dielectric constant and low dielectric loss in microwave band, so it is suitable for high T_c microwave electronic devices (for example high T_c superconductive filter in mobile communication). It is grown by Czochralsky method, possible to get large size (2" and 3" in diameter) and high quality crystal and substrate. It is an important substrate that has been applied in communication industry.

Basic Properties

Crystal Structure	Triclinic, m3m, Perovskite
Cell Parameter	$a = 3.790 \text{ \AA}$, $\alpha=90^\circ 5'$, Pseudo-cubic
Melting Point	2373K
Density	6.52g/cm ³
Specific Heat	0.427J/gk (298K)
Thermal Conductivity	11.6W/m·k (300K)
Thermal Expansion	$11.6 \times 10^{-6} \text{ k}^{-1}$ (940K)
Dielectric Constant (ϵ_r)	24 (295K), 23.7 (80K), (18-35GHz)
Dielectric Loss ($\text{tg}\delta$)	6×10^{-6} (80K) Microwave
Mohs Hardness	6.5
Growth Method	Czokralski

Substrate Specifications

Standard Size	$\phi 3''$, $\phi 2''$, $\phi 1''$, 20x20, 10x10, 10x3mm, or customer design
Thickness	0.5mm, 1.0mm
Thickness Tolerance	$\pm 0.02\text{mm}$ or $\pm 0.005\text{mm}$ for special order
Polish	one or two sides
Orientation	[100], [110], [111]
Orientation Accuracy	$\pm 0.5^\circ$
Edge Orientation Accuracy	2° (or 1° for special order)
Cut with Special Tilt Angle	available (tilt angle: $1^\circ - 45^\circ$)
Micro Roughness Ra	$\leq 5 \text{ \AA}$ ($5\mu\text{m} \times 5\mu\text{m}$)

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ZrO₂ (YSZ)

Zirconium Oxide is one of the early developed substrate and is used as many kinds of films. ZrO₂ needs a doping of element Yttrium to stabilize its crystal structure so it is called YSZ (Yttrium stabilized Zirconium oxide) normally. It has good mechanical, physical and chemical properties for films.

Basic Properties

Crystal Structure	cubic, m3m
Cell Parameter	a = 5.147 Å
Melting Point	2973K
Density	6.0g/cm ³
Specific Heat	10.3J/g · k
Dielectric Constant (ε _r)	27
Mohs Hardness	8-8.5
Growth Method	Arc Melt

Substrate Specifications

Standard Size	Φ1" , 1"x1", 20x20, 10x10, 10x5, 10x3mm, or customer design
Thickness	0.5mm, 1.0mm
Thickness Tolerance	±0.02mm or ±0.005mm for special order
Polish	one or two sides
Orientation	[100], [110], [111]
Orientation Accuracy	±0.5°
Edge Orientation Accuracy	2° (or 1° for special order)
Cut with Special Tilt Angle	available (tilt angle: 1° – 45°)
Micro Roughness Ra	≤5Å (5μm×5μm)

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LSAT

LSAT (Lanthanum Strontium Aluminum Tantalum Oxide) is a newly developed multi-functional substrate. It is grown by Czochralski method and possible to get large size (larger than 2" in diameter) and good quality by accurate controlling of the temperature distribution and growth rate. LSAT has less structure defect, no domain, no twin structure. It also has low dielectric loss in microwave band.

Basic Properties

Approximately Molecular Form	$(\text{La}_{0.3}\text{Sr}_{0.7})(\text{Al}_{0.65}\text{Ta}_{0.35})\text{O}_3$
Crystal Structure	Cubic m3m Mixed Perovskite
Cell Parameter	$a=7.737 \text{ \AA}$
Melting Point	2113K
Density	6.64g/cm ³
Specific Heat	0.57J/g.k (295K)
Thermal Conductivity	5.1W/m.k
Thermal Expansion	8.2x10 ⁻⁶ k ⁻¹ (295K), 11x10 ⁻⁶ k ⁻¹ (973K)
Dielectric Constant (ϵ_r)	22.7(291K/1MHz), 21.7(90K/10kHz)
Dielectric Loss ($\text{tg}\delta$)	7.47x10 ⁻⁵ (90K/10kHz)
Mohs Hardness	6.5
Growth Method	Czochralski
Color	None or Light yellow (if needed)

Substrate Specifications

Standard Size	$\Phi 2''$, $\Phi 1''$, 20x20, 10x10, 10x5, 10x3mm, or customer design
Thickness	0.5mm, 1.0mm
Thickness Tolerance	$\pm 0.02\text{mm}$ or $\pm 0.005\text{mm}$ for special order
Polish	one or two sides
Orientation	[100], [110], [111]
Orientation Accuracy	$\pm 0.5^\circ$
Edge Orientation Accuracy	2° (or 1° for special order)
Cut with Special Tilt Angle	available (tilt angle: 1° – 45°)
Micro Roughness Ra	$\leq 5\text{\AA}$ (5 $\mu\text{m} \times 5\mu\text{m}$)

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LiGaO₂

The lattice parameter of Lithium Dioxogallate (LiGaO₂) crystal can match with the Gallium Nitride film very well. The mismatch coefficients are 0.2% only for LiGaO₂ much smaller than that of the common used substrates such as [0001] sapphire (14%), [100] MgO (3%), [0001] SiC (3.5%). The Gallium Nitride film is a very important material for blue, violet, UV and white LED. A substrate material that matches the film to be grown well is very important to get a nice GaN epitaxial film.

Basic Properties

Substrate	LiGaO ₂
Crystal Structure	mm2, Orthorhombic
Cell Parameter	a = 5.402Å, b = 6.372Å, c = 5.007Å
Melting Point	1858 K
Density	4.187 g/cm ³
Thermal Expansion (x10 ⁻⁶ K ⁻¹)	α _a =11.8, α _b =12.5, α _c =3.7 (300K) α _a =15.5, α _b =20.5, α _c =25.2 (1100K)
Dielectric Constant (1kHz, Room Temperature)	ε _a = 7.0, ε _b = 6.5, ε _c = 8.3
Mohs Hardness	5
Growth Method	Czochralski

Substrate Specifications

Standard Size	Φ20, 20x20, 10x10, 10x5, 10x3mm or customer design
Thickness	0.5mm, 1.0mm
Thickness Tolerance	±0.02mm or ±0.005mm for special order
Polish	one or two sides
Orientation	[100], [110], [111]
Orientation Accuracy	±0.5°
Edge Orientation Accuracy	2° (or 1° for special order)
Cut with Special Tilt Angle	available (tilt angle: 1° – 45°)
Micro Roughness Ra	≤5Å (5μm×5μm)

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LiAlO₂

The lattice parameter of Lithium Aluminium Oxide (γ) (LiAlO₂) crystal can match with the Gallium Nitride film very well. The mismatch coefficients is 1.4% only for LiAlO₂, much smaller than that of the common used substrates such as [0001] sapphire (14%), [100] MgO (3%), [0001] SiC (3.5%). The Gallium Nitride film is a very important material for blue, violet, UV and white LED. A substrate material that matches the film to be grown well is very important to get a nice GaN epitaxial film.

Basic Properties

Substrate	LiAlO ₂
Crystal Structure	422 Tetragonal
Cell Parameter	a = 5.1687Å, c = 6.2676Å
Melting Point	1973 K
Density	2.615 g/cm ³
Thermal Expansion	$\alpha_a = 7.1 \times 10^{-6} \text{K}^{-1}$, $\alpha_c = 15 \times 10^{-6} \text{K}^{-1}$ (393-973K)
Hardness	6.5 (Mohs)
Growth Method	Czochralski

Substrate Specifications

Standard Size	Φ 20, 20x20, 10x10, 10x5, 10x3mm or customer design
Thickness	0.5mm, 1.0mm
Thickness Tolerance	±0.02mm or ±0.005mm for special order
Polish	one or two sides
Orientation	[100], [110], [111]
Orientation Accuracy	±0.5°
Edge Orientation Accuracy	2° (or 1° for special order)
Cut with Special Tilt Angle	available (tilt angle: 1° — 45°)
Micro Roughness Ra	≤5Å (5μm×5μm)

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GGG

Gadolinium Gallium Garnet ($Gd_3Ga_5O_{12}$) is a magneto-optical and microwave substrate. It is the best substrate material for infrared optical isolator (1.3 μ m and 1.5 μ m), which is a very important device in optical communication. It is made of YIG or BIG film on the GGG substrate plus birefringence parts. Also GGG is an important substrate for microwave isolator and other devices, its physical, mechanical and chemical properties are all good for the above applications.

Basic Properties

Molecular Form	$Gd_3Ga_5O_{12}$
Crystal Structure	Cubic, m3m, Garnet
Cell Parameter	a = 12.383 Å
Melting Point	2098K
Density	7.08 g/cm ³
Specific Heat	0.3812J/g·k
Thermal Conductivity	7.05W/m·k
Thermal Expansion	$9.18 \times 10^{-6} k^{-1}$
Dielectric Constant (ϵ_r)	12.11
Mohs Hardness	6
Growth Method	Czochralski

Substrate Specifications

Standard Size	$\Phi 25, \Phi 20, 20 \times 20, 10 \times 10, 10 \times 5, 10 \times 3$ mm or customer design
Thickness	0.5mm, 1.0mm
Thickness Tolerance	± 0.02 mm or ± 0.005 mm for special order
Polish	one or two sides
Orientation	[100], [110], [111]
Orientation Accuracy	$\pm 0.5^\circ$
Edge Orientation Accuracy	2° (or 1° for special order)
Cut with Special Tilt Angle	available (tilt angle: $1^\circ - 45^\circ$)
Micro Roughness Ra	$\leq 5 \text{Å}$ ($5 \mu\text{m} \times 5 \mu\text{m}$)

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